

P-Channel 60-V (D-S) MOSFET

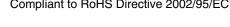
PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω) Typ.	I _D (A) ^d	Q _g (TYP.)			
-60	0.070 at V _{GS} = -10 V	-4.5	10.1 nC			
-00	0.085 at V _{GS} = -4.5 V	-4.0	10.1110			

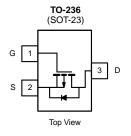
FEATURES

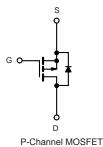
• Halogen-free According to IEC 61249-2-21 Definition



- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC







ABSOLUTE MAXIMUM RATINGS (TA =	: 25 °C, unless other	wise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-60	
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		-4.5	
Continuous Drain Current (T,I = 150 °C)	T _C = 70 °C		-4.0	
Continuous Drain Current (1) = 150 °C)	T _A = 25 °C	I _D	-3.5 ^{a,b}	
	T _A = 70 °C		-3.0 ^{a,b}	
Pulsed Drain Current (t = 100 μs)		I _{DM}	-20	
Continuous Source-Drain Diode Current	T _C = 25 °C		-3.9	
Continuous Source-Drain Diode Current	T _A = 25 °C	ls -	-2.1 ^{a,b}	
Avalanche Current	L = 0.1 mH	I _{AS}	-15	
Single-Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	11.25	mJ
	T _C = 25 °C		4.2	
Maximum Daway Dissination	T _C = 70 °C		2.7	14/
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^{a,b}	VV
	T _A = 70 °C		1.3 ^{a,b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS								
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient ^a	t ≤ 5 s	R_{thJA}	100	130	°C/W			
Maximum junction-to-case (drain)	Steady state	R_{thJF}	60	75				

- a. Surface mounted on 1" x 1" FR4 board.
- c. Maximum under steady state conditions is 110 °C/W.
- d. Based on $T_C = 25$ °C.



PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				l	l		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-6.7	-		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -250 \mu A$	-	4.3	-	mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zana Cata Valta da Busin Comunet		V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α	
Dunin Course On Chata Basistana 3	Б	$V_{GS} = -10 \text{ V}, I_D = -3.5 \text{ A}$	-	0.070	-	 -	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$	-	0.085	-	Ω	
Forward Transconductance a	9 _{fs}	$V_{DS} = -30 \text{ V}, I_D = -3.5 \text{ A}$	-	11	-	S	
Dynamic ^b				I.	•		
Input Capacitance	C _{iss}		-	832	-		
Output Capacitance	C _{oss}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	88	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	63	-		
Tatal Cata Obassa		$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.5 \text{ A}$		20	30		
Total Gate Charge	Q _g		-	10.1	15.2		
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.5 \text{ A}$	-	3.3	-	nC	
Gate-Drain Charge	Q _{gd}		-	3.9	-		
Gate Resistance	R_g	f = 1 MHz	1.8	9	18	Ω	
Turn-On Delay Time	t _{d(on)}		-	8	16		
Rise Time	t _r	V_{DD} = -30 V, R_L = 10.7 Ω	-	6	12		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -2.8 A, $V_{GEN}=$ -10 V, $R_g=$ 1 Ω	-	35	53		
Fall Time	t _f		-	16	24		
Turn-On Delay Time	t _{d(on)}		-	40	60	ns	
Rise Time	t _r	V_{DD} = -30 V, R_L = 10.7 Ω	-	28	42		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ -2.8 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω	-	31	47		
Fall Time	t _f		-	15	23		
Drain-Source Body Diode Characterist	ics			l .	•		
Continous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	-3.5	_	
Pulse Diode Forward Current (t = 100 μs)	I _{SM}		-	-	-20	A	
Body Diode Voltage	V _{SD}	I _S = -2.8 A, V _{GS} = 0 V	-	-0.85	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	32	48	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = -2.8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s},$	-	45	68	nC	
Reverse Recovery Fall Time	ta	$T_J = 25 ^{\circ}C$	-	24	-		
Reverse Recovery Rise Time	t _b		-	8	-	ns	

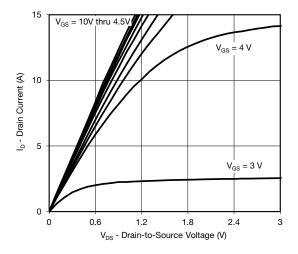
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

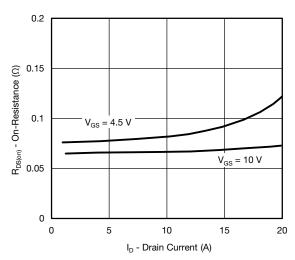
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



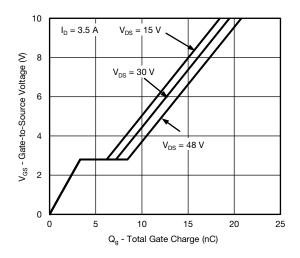
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



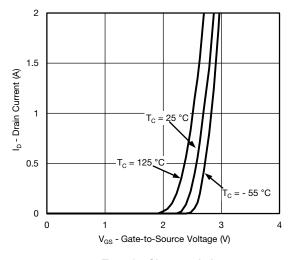
Output Characteristics



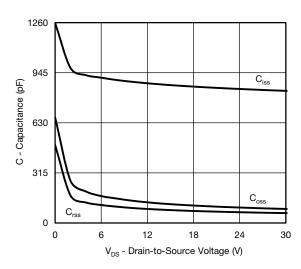
On-Resistance vs. Drain Current



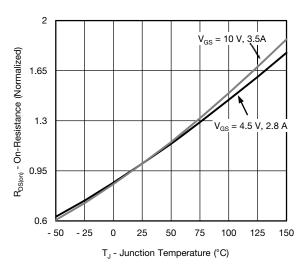
Gate Charge



Transfer Characteristics



Capacitance

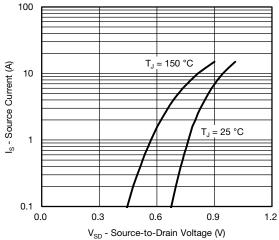


On-Resistance vs. Junction Temperature

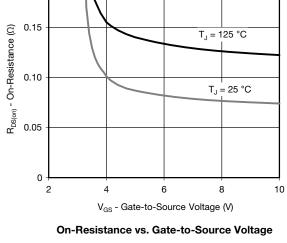


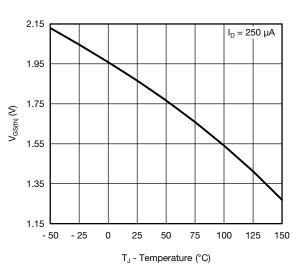
 $I_D = 3.5 A$

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





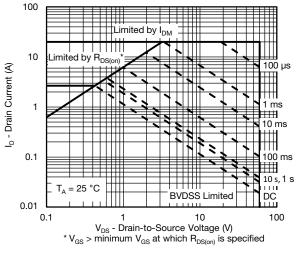




50 40 30 10 10-3 10-2 10-1 10 100 600 Time (s)

Threshold Voltage

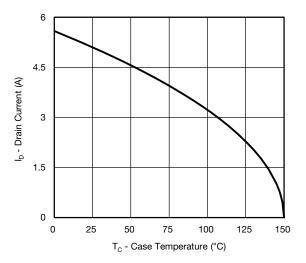
Single Pulse Power, Junction-to-Ambient



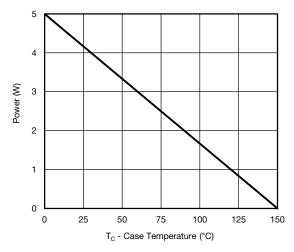
Safe Operating Area



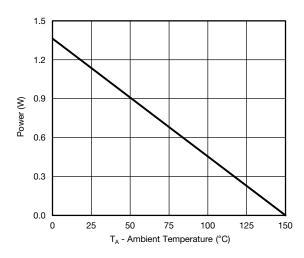
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*







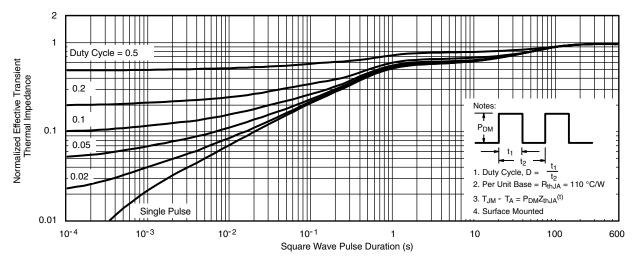
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J \text{ (max.)}} = 150 \,^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

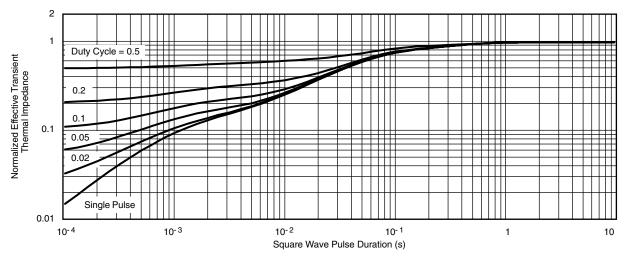
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



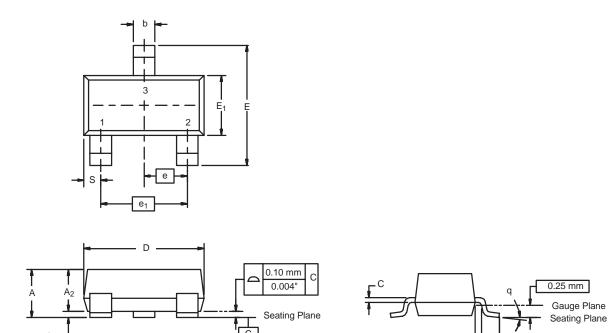
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD

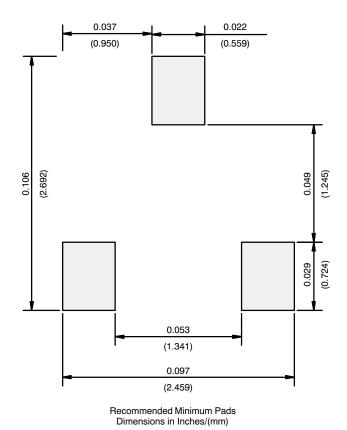


Dim -	MILLIM	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95	0.95 BSC		4 Ref	
e ₁	1.90	1.90 BSC		8 Ref	
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025	Ref	
S	0.50 Ref		0.020) Ref	
q	3°	8°	3°	8°	

DWG: 5479



RECOMMENDED MINIMUM PADS FOR SOT-23



服务热线:400-655-8788



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